

MAGISOL plug-in Set-up **Status**

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EXPERIMENTAL SET-UP



MAGISOL Si-PLUGIN CHAMBER



MAGISOL Si-PLUGIN CHAMBER

PCB cards

PCB with tracks for 6 DSSD's (1 horizontal, 5 vertical DSSD's)



PCB with 3 added plugins for 3 PAD's



EXPERIMENTAL SET-UP: DATA ADQUISITION



ELECTRONIC SCHEME



AIMS OF THE WORK

- To reduce level noise
- To verify the path between the PCB and the preamplifiers inputs
- To check the detectors in all positions of the PCB with the data adquisition system
- To measure the energy resolution of the detectors
- •Dynamic range of the preamplifers
- To check if we can reach low energies (cutoff with pulser)

Reducing level noise



Lateral PCB on the left side has more noise that the lateral PCB in the right side

The third position on the lateral PCB in the left side has more noise than the other positions

We are able to reduce level noise and to get similar resolutions in all positions (right side and left side).

Verify electronic tracks



Verify the path between the PCB and the preamplifiers inputs

•Checking with a voltimeter track by track

•We found **6 errors in the PCB that we fixed** (problems with weldings on the PCB), and other **2 errors in the lateral PCB** (left side) that we will **fix soon.**





TWO ERRORS IN THE LATERAL PCB (WELDINGS)



Detector positions

Check the detectors in all positions of the PCB with the data adquisition system



All the positions work well.



•Measurements with one, two or three DSSD's in all positions.

•Measurements with 1 PAD and 1 DSSD.

•Detectors: 295 μm, 297 μm, 61 μm (DSSD's) and 500 μm (PAD).

•Source: triple alfa

•Data adquisition software: MIDAS

Energy resolution of the detectors

	DSSD1		DSSD2		DSSD3		PAD
Thickness (µm)	295		297		60		500
Position	Vertical		Vertical		Horizontal		Vertical
V(V)	-75		-60		-25		-60
Ι(μΑ)	0.21		1.0		0.09		0.19
Dynamic range (MeV)	20	100	20	100	20	100	20
Resolution (KeV)	21.9	33.6	26.3	37.4	49.6	40.27	31.7

The best results are obtained with DSSD1 (295μm).
Horizontal position has worse resolution.

Dynamic range

Total Amplification: preamplifier amplification+ amplifier amplification





What it is better, 20 MeV or 100 MeV?

>Maximum amplifier amplification (16.4) + 100 MeV \longrightarrow limited energy range and worst resolution

Small amplifier amplification (7.4) + 20 MeV \longrightarrow bigger energy range and better resolution

Dynamic range of 20 MeV is chosen for the measurements.

Cut off

- •Detector:295 μm, -75V, 0.19 μA
- •Source:¹⁴⁸Gd
- •Pulser amplitude: 0.23245 V
- CAEN Attenuator (in dB)
- •We choose only 1 channel to avoid noise





With the alfa peak and the pulser peak \rightarrow calibration line

With the attenuator, the pulse amplitude is reduced in factors of dB;

the lowest amplitude is the lowest energy in our enegy spectra.

We reach low energies: **150 keV**

CONCLUSIONS

- We have checked all the electric tracks between connections
- All positions in the PCB work well
- We obtain good resolutions (< 22 keV)
- 20 MeV of dynamic range is better for the resolution.
- We reach low cutoff energy (150 KeV).



THANK YOU FOR YOUR ATTENTION

